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APPLICATION NO.	FIL	ING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/636,028	08/06/2003		Cem Basceri	MI22-2233	1038
21567	7590	02/07/2006		EXAMINER	
WELLS ST				CHAUDHR	Y, SAEED T
601 W. FIRS SPOKANE,		E, SUITE 1300 01		ART UNIT	PAPER NUMBER
 ,				1746	

DATE MAILED: 02/07/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)	
	10/636,028	BASCERI ET AL.	
Office Action Summary	Examiner	Art Unit	
	Saeed T. Chaudhry	1746	
The MAILING DATE of this communication a Period for Reply	appears on the cover sheet wit	h the correspondence address	
A SHORTENED STATUTORY PERIOD FOR REF WHICHEVER IS LONGER, FROM THE MAILING - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory perions failure to reply within the set or extended period for reply will, by stated the period for reply within the set or extended period for reply will, by stated any reply received by the Office later than three months after the material earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNIC 1.136(a). In no event, however, may a re od will apply and will expire SIX (6) MONT tute, cause the application to become ABA	ATION. ply be timely filed HS from the mailing date of this communication ANDONED (35 U.S.C. § 133).	
Status		•	
 Responsive to communication(s) filed on 18 This action is FINAL. Since this application is in condition for allow closed in accordance with the practice under the condition is in condition. 	nis action is non-final. vance except for formal matte	•	is
Disposition of Claims	,	.,,	
4) Claim(s) 1-23 is/are pending in the application 4a) Of the above claim(s) is/are withdress 5) Claim(s) is/are allowed. 6) Claim(s) 1-23 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and complete to the com	rawn from consideration.		
9) The specification is objected to by the Exami 10) The drawing(s) filed on is/are: a) and an applicant may not request that any objection to the Replacement drawing sheet(s) including the correction. 11) The oath or declaration is objected to by the	ccepted or b) objected to be the drawing(s) be held in abeyand the drawing(s) be the drawing(s)	e. See 37 CFR 1.85(a). s) is objected to. See 37 CFR 1.121((d).
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority docume 2. Certified copies of the priority docume 3. Copies of the certified copies of the priority docume application from the International Bure * See the attached detailed Office action for a list	ints have been received. Ints have been received in Ap iority documents have been reau (PCT Rule 17.2(a)).	plication No eceived in this National Stage	
Attachment(s)	4) ☐ Interview Su	mmary (PTO-413)	

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DETAILED ACTION

Applicant's amendments and remarks filed November 18, 2005 have been acknowledged by the examiner and entered. Claims 1-23 are pending in this application for consideration.

Rejection of claims 6 and 9 under 35 U.S.C. § 112, second paragraph has been withdrawn in view of the amendments filed November 18, 2005.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

The factual inquiries set forth in Graham v. John Deere Co., 148 USPQ 459, that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:

- 1. Determining the scope and contents of the prior art.
- 2. Ascertaining the differences between the prior art and the claims at issue.
- 3. Resolving the level of ordinary skill in the pertinent art.
- 4. Considering objective evidence present in the application indicating obviousness or unobviousness.

Claims 1-4, 6-16, and 18-23 are rejected under 35 U.S.C. § 103(a) as being unpatentable over Chen et al in view of Cotte et al.

Chen et al (5,356,478) disclose a method for removing residues previously formed in a plasma chamber by dry etching layers such as photoresist, barriers, etc. It is conventional to dry etch a stack of thin layers which can include photoresist (for patterning the underlying layers), an anti-reflective coating, aluminum, and a barrier material. Such etching, however, results in residues or deposits building up on surfaces inside the plasma treatment chamber 9see abstract and col. 1, lines 11-37). Chen et al fails to use supercritical fluid for cleaning the residue from the walls of the chamber.

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Cotte et al (6,454,869) disclose a method of removing organic material from a surface of semiconductor manufacturing equipment. A semiconductor processing, handling and manufacturing equipment 16 to be cleaned is introduced into a cleaning zone 14 of a processing chamber 12 wherein the equipment 16 is exposed to liquid carbon dioxide or supercritical carbon dioxide. To ensure that the liquid carbon dioxide and supercritical carbon dioxide remains in the liquid or supercritical state during processing, the processing chamber 12 is maintained at a pressure in the range of between about 1,000 psi and about 6,000 psi. The temperature within processing chamber 12 is maintained in a range of between about 40.degree. C. and about 100.degree. C. (see col. 2, lines 37-57).

Liquid or supercritical carbon dioxide is provided into processing chamber 12 by means of a liquid or supercritical carbon dioxide source 30 (see col. 2, lines 66-67). The semiconductor processing, handling and manufacturing equipment 16 to be cleaned in accordance with the present invention, as stated above, is introduced into sample zone 14 of the chamber 12 wherein it is exposed to liquid or supercritical carbon dioxide (see col. 3, lines 19-23).

As those skilled in the art are aware, coating of semiconductor wafers with photoresists is a critical processing step in the formation of semiconductor chips. Typically, a photoresist is cast upon semiconductor wafers while the wafers are rotated to provide a uniform coating thereupon. Such turntable assemblies are schematically represented at 44 in FIG. 4. Obviously, these assemblies are contacted with photoresist residue which falls off wafers during application. As such, they are ideal candidates for cleaning in accordance with the process of the present invention (see col. 3, lines 44-56).

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A photoresist may be better processed when the liquid or supercritical carbon dioxide

present invention, the cleaning agent is a liquid or supercritical carbon dioxide composition

contacts the photoresist in the presence of a surfactant. Thus, in a preferred embodiment of the

which includes a surfactant (see col. 3, lines 60-65).

The composition employed in the process of the invention can, in addition to supercritical or liquid carbon dioxide and a surfactant, include a further component, a co-solvent (see col. 4, lines 58-60).

It would have been obvious at the time applicant invented the claimed process to incorporate the cited steps of introducing a supercritical fluid such as carbon dioxide composition as disclosed by Cotte et al into the process of Chen et al for purpose of removing residue such as photoresist from the internal surfaces of the chamber. This is because Chen et al disclose that it is conventional to remove residue or build up on surfaces inside the plasma treatment chamber. Further, one of ordinary skill in the art would utilize supercritical fluid for effectively removing the residue such as photoresist from the inside of the chamber, since Cotte et al disclose that photoresist is effectively removed by contacting with liquid or supercritical carbon dioxide.

Further Cotte et al disclose to remove organic or inorganic residue from the surfaces with supercritical fluid such as carbon dioxide. Therefore, one of ordinary skill in the art would expect that the residues as claimed in claim 2 and residue from the trap or dispenser will be removed by the supercritical fluid.

Claim 5 is rejected under 35 U.S.C. § 103(a) as being unpatentable over Chen et al in view of Cotte et al as applied to claim 1 above, and further in view of Goffnett et al.

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Chen et al and Cotte et al were discussed <u>supra</u>. However, the reference fails to disclose that the processing chamber is selected from the group of a CVD chamber.

Goffnett et al (5,108,512) disclose a method for removing inner surface of a CVD chamber with pellets of carbon dioxide (see claims).

It would have been obvious at the time applicant invented the claimed process to clean a CVD chamber with the process of Cotte et al because it is known in the art to clean a CVD chamber as disclosed by Goffnett et al and one would expect that supercritical fluid would remove the residue in the CVD chamber because Cotte et al disclose to remove organic and inorganic residues.

Claims 17 is rejected under 35 U.S.C. 103(a) as being unpatentable over Chen et al in view of Cotte et al as applied to claim 1 above, and further in view of Smith, Jr. et al.

Chen et al and Cotte et al were discussed <u>supra</u>. However, the reference fails to treat the surface with solvent before the treatment with supercritical fluid.

Smith, Jr. et al (5,417,768) disclose to remove residue from a surface by treating with a primary solvent and then flushing the solvent from the vessel and supplying carbon dioxide at supercritical conditions (see col. 5, lines 49-51 and claims).

It would have been obvious at the time applicant invented the claimed process to pre-treat the surface with a solvent as disclosed by Smith, Jr. et al into the processes of Jackson et al or Cotte et al to enhance the cleaning effect.

Applicant's arguments with respect to claims 1-23 have been considered but are deemed to be most in view of the new grounds of rejection.

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Applicant's amendment necessitated the new grounds of rejection. Accordingly, THIS ACTION IS MADE FINAL. See M.P.E.P. § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 C.F.R. § 1.136(a).

A SHORTENED STATUTORY PERIOD FOR RESPONSE TO THIS FINAL ACTION IS SET TO EXPIRE THREE MONTHS FROM THE DATE OF THIS ACTION. IN THE EVENT A FIRST RESPONSE IS FILED WITHIN TWO MONTHS OF THE MAILING DATE OF THIS FINAL ACTION AND THE ADVISORY ACTION IS NOT MAILED UNTIL AFTER THE END OF THE THREE-MONTH SHORTENED STATUTORY PERIOD, THEN THE SHORTENED STATUTORY PERIOD WILL EXPIRE ON THE DATE THE ADVISORY ACTION IS MAILED, AND ANY EXTENSION FEE PURSUANT TO 37 C.F.R. § 1.136(a) WILL BE CALCULATED FROM THE MAILING DATE OF THE ADVISORY ACTION. IN NO EVENT WILL THE STATUTORY PERIOD FOR RESPONSE EXPIRE LATER THAN SIX MONTHS FROM THE DATE OF THIS FINAL ACTION.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Saeed T. Chaudhry whose telephone number is (571) 272-1298. The examiner can normally be reached on Monday-Friday from 9:30 A.M. to 4:00 P.M.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Mr. Michael Barr, can be reached on (571)-272-1414. The fax phone number for non-final is (703)-872-9306.

When filing a FAX in Gp 1700, please indicate in the Header (upper right) "Official" for papers that are to be entered into the file, and "Unofficial" for draft documents and other communication with the PTO that are for entry into the file of the application. This will expedite processing of your papers.

Any inquiry of a general nature or relating to the status of this application should be directed to the Group receptionist whose telephone number is (571) 272-1700.

Saeed T. Chaudhry

Patent Examiner

MICHAEL BARR SUPERVISORY PATENT EXAMINER